EMI INPUT FILTER 28 VOLT INPUT

STF28-461 EMI FILTER 0.8 AMP

FEATURES

- Fully qualified to Class H or K
- Passive components for maximum tolerance in space environments
- -55° to +125°C operation
- 28 volt input
- Up to 0.8 amps throughput current
- 50 dB minimum attenuation at 500 kHz
- Compliant to MIL-STD-461C, CE03
- Compatible with MIL-STD-704E DC power bus



MODEL STF28-461 0.8 amp

Size (max.): 0.975 x 0.800 x 0.270 (24.77 x 20.32 x 6.86 mm)

See Section B8, cases A1, for dimensions.

10.3 grams typical, 11.5 grams maximum

Screening: Standard, Class H, or Class K (MIL-PRF-38534)

See Section C2 for screening options, see

Section A5 for ordering information.

DESCRIPTION

The STF28-461™ EMI filter module has been designed as a companion for Interpoint SMSA flyback power converters. Multiple SMSA power converters can be operated from a single filter provided the total power line current does not exceed the filter maximum rating. The STF filter will reduce the SMSA's power line reflected ripple current to within the limit of MIL-STD-461C, Method CE03, as shown in the example of Figures 4 and 5.

The STF filter is fabricated using thick film hybrid technology and is sealed in a metal package for space, military, aerospace and other applications requiring EMI suppression.

SCREENING AND REPORTS

The STF28-461 filter offers three screening options – Standard, Class H, or Class K. See Section C2, Quality Assurance, pages C2-7 through C2-9, for descriptions. Detailed reports on product performance are also available and are listed on page C2-9.

OPERATION

The SMSA power converter has an internal capacitor across its input power terminals. When the SMSA and STF filters are used together, this capacitor becomes part of the filter and forms its final LC output section.

The STF filter provides both differential and common mode rejection bringing DC/DC converters into compliance with MIL-STD-461C CE03. It is designed to be used with the SMSA, SMHF, and MCH Series of converters. The STF filter can be used with multiple converters up to the rated current of the filter.

For more information, contact your Interpoint representative listed in Section A5.



Dot on top of case indicates pin one. CASE A **BOTTOM VIEW** 0.800 max See Figures 2 - 4 (20.32)for pin configurations. 0.975 max (24.77)Materials Header

Kovar/Nickel/Gold (Case A3, Kovar/Nickel)

Kovar/Nickel Cover Kovar/Nickel/Gold, Pins matched glass seal

Case dimensions in inches (mm)

Tolerance ±0.005 (0.13) for three decimal places

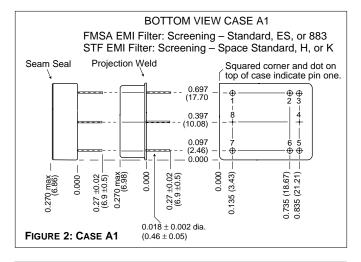
 ± 0.01 (0.3) for two decimal places unless otherwise specified

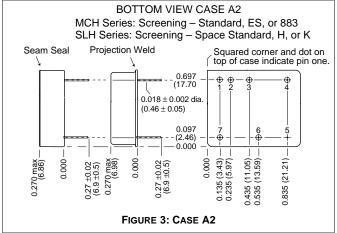
CAUTION

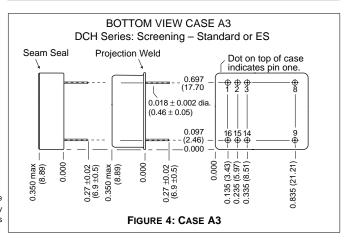
Heat from reflow or wave soldering may damage the device. Solder pins individually with heat application not exceeding 300°C for 10 seconds per pin.

FIGURE 1: CASE A MAXIMUM DIMENSIONS

CASES







Note: Although every effort has been made to render the case drawings at actual size, variations in the printing process may cause some distortion. Please refer to the numerical dimensions for accuracy.



SPACE PRODUCTS

ELEMENT EVALUATION TEST PERFORMED	STANDARD (O)		CLASS H		CLASS K	
(COMPONENT LEVEL)	M/S	P	M/S	Р	M/S	Р
Element Electrical	yes	no	yes	yes	yes	yes
Element Visual	no	no	yes	yes	yes	yes
Internal Visual	no	no	yes	no	yes	no
Temperature Cycling	no	no	no	no	yes	yes
Constant Acceleration	no	no	no	no	yes	yes
Interim Electrical	no	no	no	no	yes	no
Burn-in	no	no	no	no	yes	no
Post Burn-in Electrical	no	no	no	no	yes	no
Steady State Life	no	no	no	no	yes	no
Voltage Conditioning /Aging	no	no	no	no	no	yes
Visual Inspection	no	no	no	no	no	yes
Final Electrical	no	no	yes	yes	yes	yes
Wire Bond Evaluation*	no	no	yes	yes	yes	yes
SEM	no	no	no	no	yes	no
SLAM™/C-SAM: Input capacitors only (Add'I test, not req. by H or K)	no	no	no	yes	no	yes

Notes

M/S Active components (Microcircuit and Semiconductor Die)

P Passive components

* Not applicable to EMI filters that have no wirebonds

Definitions

Element Evaluation: Component testing/screening per MIL-STD-883 as determined by MIL-PRF-38534

SEM: Scanning Electron Microscopy

SLAM™: Scanning Laser Acoustic Microscopy C-SAM: C - Mode Scanning Acoustic Microscopy

Applies to the following products:

SMFLHP Series SSP Series SLIM Module SFMC EMI Filter SMFL Series SMHF Series SFME120 EMI Filter STF EMI Filter SMHP Series (O&H only) SMSA Series SFME28 EMI Filter SMTR Series SLH Series SFCS EMI Filter



QA SCREENING SPACE PRODUCTS

ENVIRONMENTAL SCREENING			
TEST PERFORMED	STANDARD	CLASS	CLASS
(END ITEM LEVEL)	(0)	Н	K
Non-destruct bond pull*			
Method 2023	no	no	yes
Pre-cap inspection			
Method 2017, 2032	yes	yes	yes
Temperature cycle			
Method 1010, Cond. C	yes	yes	yes
Constant acceleration			
Method 2001, 3000 g	yes	yes	yes
PIND Test			
Method 2020, Cond. B	no	no	yes
Radiography			
Method 2012	no	no	yes
Pre burn-in test	yes	yes	yes
Burn-in, Method 1015, 125°C			
96 hours	yes	no	no
160 hours	no	yes	no
2 x 160 hour (includes mid BI test)	no	no	yes
Final electrical test			
MIL-PRF-38534, Group A	yes	yes	yes
Hermeticity test			
Fine Leak,			
Method 1014, Cond. A	yes	yes	yes
Gross Leak,			
Method 1014, Cond. C	yes	yes	yes
Final visual inspection			
Method 2009	yes	yes	yes

Test methods are referenced to MIL-STD-883 as determined by MIL-PRF-38534.

Note

Applies to the following products:

SMFLHP Series
SMFL Series
SMFL Series
SMSA Series
SMHP Series (O&H only)
SLH Series
SMTR Series
SLIM Module
SSP Series
SFME120 EMI Filter

SFME28 EMI Filter SFCS EMI Filter SFMC EMI Filter STF EMI Filter



^{*} Not applicable to EMI filters that have no wirebonds.